Specifications are subject to change without notice.
Revised: 05/12/17

TVS Diode Arrays (SPA® Diodes)
General Purpose ESD Protection - SP724 Series

SP724 Series 3pF 8kV Diode Array

Description
The SP724 is a quad array of transient voltage clamping circuits designed to suppress ESD and other transient over-voltage events. The SP724 is used to help protect sensitive digital or analog input circuits on data, signal, or control lines operating on power supplies up to 20VDC.

The SP724 is comprised of bipolar SCR/diode structures to protect up to four independent lines by clamping transients of either polarity to the power supply rails. The SP724 offers very low leakage (1nA Typical) and low input capacitance (3pF Typical). Additionally, the SP724 is rated to withstand the IEC 61000-4-2 ESD specification for both contact and air discharge methods to level 4.

The SP724 is connected to the sensitive input line and its associated power supply lines. Clamping action occurs during the transient pulse, turning on the diode and fast triggering SCR structures when the voltage on the input line exceeds one $V_{BE}$ threshold above the $V+$ supply (or one $V_{BE}$ threshold below the $V-$ supply). Therefore, the SP724 operation is unaffected by poor power supply regulation or voltage fluctuations within its operating range.

Features
- An Array of 4 SCR/Diode Pairs in 6-Lead SOT-23
- ESD Capability per HBM Standards
  - IEC 61000-4-2, Direct Discharge ........... 8kV (Level 4)
  - IEC 61000-4-2, Air Discharge.............15kV (Level 4)
  - MIL STD 3015.7................................................ >8kV
- Input Protection for Applications with Power Supplies Up to +20V (Single-Ended Voltage), and ±10V (Differential Voltage)
- Peak Current Capability
  - IEC 61000-4-5 (8/20µs)............................................. ±3A
  - Single Pulse, 100µs Pulse Width ..................... ±2.2A
- Low Input Leakage.............................................. 1nA Typical
- Low Input Capacitance......................................3pF Typical
- Operating Temperature Range......................-40ºC to 105ºC

Applications
- Microprocessor/Logic Input Protection
- Data Bus Protection
- Analog Device Input Protection
- Voltage Clamp

Additional Information

Notes:
1. The design of the SP724 SCR/Diode ESD Protection Arrays are covered by Littelfuse patent 4567500.
2. The full ESD capability of the SP724 is achieved when wired in a circuit that includes connection to both the $V+$ and $V-$ pins. When handling individual devices, follow proper procedures for electrostatic discharge.

Life Support Note:
Not Intended for Use in Life Support or Life Saving Applications
The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

© 2017 Littelfuse, Inc.
Specifications are subject to change without notice.
Revised: 05/12/17
Absolute Maximum Ratings

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Rating</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Continuous Supply Voltage, ((V+) - (V-))</td>
<td>+20</td>
<td>V</td>
</tr>
<tr>
<td>Forward Peak Current, (I_{IN} to V_{CC} , GND) (Refer to Figure 5)</td>
<td>±2.2, 100µs</td>
<td>A</td>
</tr>
</tbody>
</table>

CAUTION: Stresses above those listed in “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Note:
ESD Ratings and Capability - See Figure 1, Table 1

Electrical Characteristics  \(T_{A} = -40^\circ C to 105^\circ C, V_{SUPPLY} = 0.5V_{CC} \) - Unless Otherwise Specified

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Test Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Operating Voltage Range, (V_{SUPPLY} = [(V+) - (V-)] (Notes 4, 5)</td>
<td></td>
<td></td>
<td>1</td>
<td>-</td>
<td>20</td>
<td>V</td>
</tr>
<tr>
<td>Forward Voltage Drop</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Forward Voltage Drop (I_{IN} = 1A (Peak Pulse))</td>
<td></td>
<td></td>
<td>-</td>
<td>2</td>
<td>-</td>
<td>V</td>
</tr>
<tr>
<td>IN to V-</td>
<td></td>
<td></td>
<td>-10</td>
<td>1</td>
<td>10</td>
<td>nA</td>
</tr>
<tr>
<td>Quiescent Supply Current (I_{QUIESCENT})</td>
<td></td>
<td></td>
<td>-</td>
<td>-</td>
<td>100</td>
<td>nA</td>
</tr>
<tr>
<td>Equivalent SCR ON Threshold (V_{FWD} = 20V, V_{-} = GND)</td>
<td></td>
<td></td>
<td>-</td>
<td>1.1</td>
<td>-</td>
<td>V</td>
</tr>
<tr>
<td>Equivalent SCR ON Resistance (V_{FVD}/I_{FVD}) (Note 6)</td>
<td></td>
<td></td>
<td>-</td>
<td>1.0</td>
<td>-</td>
<td>Ω</td>
</tr>
<tr>
<td>Input Capacitance (C_{IN})</td>
<td></td>
<td></td>
<td>-</td>
<td>3</td>
<td>-</td>
<td>pF</td>
</tr>
</tbody>
</table>

Notes:
4. In automotive and other battery charging systems, the SP724 power supply lines should be externally protected for load dump and reverse battery. When the V+ and V- Pins are connected to the same supply voltage source as the device or control line under protection, a current limiting resistor should be connected in series between the external supply and the SP724 supply pins to limit reverse battery current to within the rated maximum limits.
5. Bypass capacitors of typically 0.01µF or larger should be connected closely between the V+ and V- Pins for all applications.
6. Refer to the Figure 3 graph for definitions of equivalent “SCR ON Threshold” and “SCR ON Resistance”. These characteristics are given here for information to determine peak current and dissipation under EOS conditions.

Typical Application of the SP724

Application as an Input Clamp for Over-voltage, Greater than 1V_{BE} Above V+ or less than -1V_{BE} below V-
ESD Capability

ESD rating is dependent on the defined test standard. The evaluation results for various test standards and methods based on Figure 1 are shown in Table 1.3

The SP724 has a Level 4 rating when tested to the IEC 61000-4-2 Human Body Model (HBM) standard and connected in a circuit in which the V+ and V- pins have a return path to ground. Level 4 specifies a required capability greater than 8kV for direct discharge and greater than 15kV for air discharge.

The “Modified” MIL-STD-3015.7 condition is defined as an “in-circuit” method of ESD testing, the V+ and V- pins have a return path to ground. The SP724 ESD capability is greater than 8kV with 100pF discharged through 1.5kΩ. By strict definition of the standard MIL-STD-3015.7 method using “pin-to-pin” device testing, the ESD voltage capability is greater than 2kV.

For the SP724 EIAJ IC121 Machine Model (MM) standard, the ESD capability is typically greater than 1.8kV with 200pF discharged through 0kΩ.

The Charged Device model is based upon the self-capacitance of the SOT-23 package through 0kΩ.

### Table 1: ESD Test Conditions

<table>
<thead>
<tr>
<th>Standard</th>
<th>Type/Mode</th>
<th>R&lt;sub&gt;D&lt;/sub&gt;</th>
<th>C&lt;sub&gt;D&lt;/sub&gt;</th>
<th>±V&lt;sub&gt;D&lt;/sub&gt;</th>
</tr>
</thead>
<tbody>
<tr>
<td>IEC 61000-4-2</td>
<td>HBM, Air Discharge</td>
<td>330 Ω</td>
<td>150pF</td>
<td>15kV</td>
</tr>
<tr>
<td></td>
<td>HBM, Direct Discharge</td>
<td>330 Ω</td>
<td>150pF</td>
<td>8kV</td>
</tr>
<tr>
<td>MIL-STD-3015.7</td>
<td>Modified HBM</td>
<td>1.5k Ω</td>
<td>100pF</td>
<td>±8kV†</td>
</tr>
<tr>
<td></td>
<td>Standard HBM</td>
<td>1.5k Ω</td>
<td>100pF</td>
<td>2kV</td>
</tr>
<tr>
<td>EIAJ IC121</td>
<td>Machine Model</td>
<td>0k Ω</td>
<td>200pF</td>
<td>400V</td>
</tr>
<tr>
<td>US ESD DS 5.3</td>
<td>Charged Device Model</td>
<td>0k Ω</td>
<td>NA</td>
<td>3kV</td>
</tr>
</tbody>
</table>

†Upper limit of laboratory test set.

---

© 2017 Littelfuse, Inc.
Specifications are subject to change without notice.
Revised: 05/12/17
Peak Transient Current Capability for Long Duration Surges

The peak transient current capability is inversely proportional to the width of the current pulse. Testing was done to fully evaluate the SP724’s ability to withstand long duration current pulses using the circuit of Figure 4. Figure 5 shows the point of overstress as defined by increased leakage in excess of the data sheet published limits. The safe operating range of the transient peak current should be limited to no more than 75% of the measured overstress level for any given pulse width as shown in the curve of Figure 5.

The test circuit of Figure 4 is shown with a positive pulse input. For a negative pulse input, the (-) current pulse input goes to the SP724 ‘IN’ input pin and the (+) current pulse input goes to the SP724 V- pin. The V+ to V- supply of the SP724 must be allowed to float. (i.e., It is not tied to the ground reference of the current pulse generator.)

Note that two input pins of the SP724 may be paralleled to improve current (and ESD) capability. The sustained peak current capability is increased to nearly twice that of a single pin.

Figure 4: Typical SP724 Peak Current Test Circuit with a Variable Pulse Width Input

Figure 5: SP724 Typical Nonrepetitive Peak Current Pulse Capability

Showing the Measured Point of Overstress in Amperes vs pulse width time in milliseconds
### Soldering Parameters

**Reflow Condition**

- Temperature Min \(T_{\text{min}}\) (\(T_s\text{(min)}\)) 150°C
- Temperature Max \(T_{\text{max}}\) (\(T_s\text{(max)}\)) 200°C
- Time (min to max) \(t_s\) 60 – 180 secs

**Average ramp up rate (Liquidus) Temp \(T_s\) to peak**

5°C/second max

**\(T_{\text{max}}\) to \(T_L\) - Ramp-up Rate**

5°C/second max

**Reflow**

- Temperature (\(T_L\) (Liquidus)) 217°C
- Temperature \(t_L\) 60 – 150 seconds

**Peak Temperature \(T_P\)**

260°C

**Time within 5°C of actual peak Temperature \(t_P\)**

20 – 40 seconds

**Ramp-down Rate**

5°C/second max

**Time 25°C to peak Temperature \(T_P\)**

8 minutes Max.

**Do not exceed**

260°C

---

### Package Dimensions — Small Outline Transistor Plastic Packages (SOT23-6)

#### Package SOT23-6

**Pins**

6

**JEDEC**

MO-178

#### Table of Dimensions

<table>
<thead>
<tr>
<th>Package</th>
<th>SOT23-6</th>
</tr>
</thead>
<tbody>
<tr>
<td>Pins</td>
<td>6</td>
</tr>
</tbody>
</table>

#### Dimensions

<table>
<thead>
<tr>
<th>Notes</th>
<th>Min</th>
<th>Max</th>
<th>Min</th>
<th>Max</th>
</tr>
</thead>
<tbody>
<tr>
<td>A</td>
<td>0.900</td>
<td>1.450</td>
<td>0.035</td>
<td>0.057</td>
</tr>
<tr>
<td>A1</td>
<td>0.000</td>
<td>0.150</td>
<td>0.000</td>
<td>0.006</td>
</tr>
<tr>
<td>A2</td>
<td>0.900</td>
<td>1.300</td>
<td>0.035</td>
<td>0.051</td>
</tr>
<tr>
<td>b</td>
<td>0.350</td>
<td>0.500</td>
<td>0.0138</td>
<td>0.0196</td>
</tr>
<tr>
<td>C</td>
<td>0.080</td>
<td>0.220</td>
<td>0.0031</td>
<td>0.009</td>
</tr>
<tr>
<td>D</td>
<td>2.800</td>
<td>3.000</td>
<td>0.11</td>
<td>0.118</td>
</tr>
<tr>
<td>E</td>
<td>2.600</td>
<td>3.000</td>
<td>0.102</td>
<td>0.118</td>
</tr>
<tr>
<td>E1</td>
<td>1.500</td>
<td>1.750</td>
<td>0.06</td>
<td>0.069</td>
</tr>
<tr>
<td>e</td>
<td>0.95 Ref</td>
<td>0.0374 Ref</td>
<td></td>
<td></td>
</tr>
<tr>
<td>e1</td>
<td>1.9 Ref</td>
<td>0.0748 Ref</td>
<td></td>
<td></td>
</tr>
<tr>
<td>L</td>
<td>0.100</td>
<td>0.600</td>
<td>0.004</td>
<td>0.023</td>
</tr>
<tr>
<td>N</td>
<td>6</td>
<td>6</td>
<td>6</td>
<td></td>
</tr>
<tr>
<td>a</td>
<td>0°</td>
<td>10°</td>
<td>0°</td>
<td>10°</td>
</tr>
<tr>
<td>M</td>
<td>2.590</td>
<td>0.102</td>
<td></td>
<td></td>
</tr>
<tr>
<td>O</td>
<td>0.690</td>
<td>0.027 TYP</td>
<td></td>
<td></td>
</tr>
<tr>
<td>P</td>
<td>0.990</td>
<td>0.039 TYP</td>
<td></td>
<td></td>
</tr>
<tr>
<td>R</td>
<td>0.950</td>
<td>0.038</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

**Notes:**

3. Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs.
4. Footprint L measured at reference to seating plane.
5. “L” is the length of flat foot surface for soldering to substrate.
6. “N” is the number of terminal positions.
7. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

---

© 2017 Littelfuse, Inc.
Specifications are subject to change without notice.
Revised: 05/12/17
TVS Diode Arrays (SPA® Diodes)
General Purpose ESD Protection - SP724 Series

Part Numbering System

<table>
<thead>
<tr>
<th>SP 724</th>
<th>AH</th>
<th>TG</th>
</tr>
</thead>
<tbody>
<tr>
<td>TVS Diode Arrays (SPA® Diodes)</td>
<td>“Green” RoHS Compliant</td>
<td>Tape and Reel</td>
</tr>
<tr>
<td>Series</td>
<td>Tape</td>
<td>Package Type</td>
</tr>
<tr>
<td>AH: SOT-23</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Product Characteristics

<table>
<thead>
<tr>
<th>Description</th>
<th>Specification</th>
</tr>
</thead>
<tbody>
<tr>
<td>Lead Plating</td>
<td>Matte Tin</td>
</tr>
<tr>
<td>Lead Material</td>
<td>Copper Alloy</td>
</tr>
<tr>
<td>Lead Coplanarity</td>
<td>0.004 inches (0.102mm)</td>
</tr>
<tr>
<td>Substitute Material</td>
<td>Silicon</td>
</tr>
<tr>
<td>Body Material</td>
<td>Molded Epoxy</td>
</tr>
<tr>
<td>Flammability</td>
<td>UL 94 V-0</td>
</tr>
</tbody>
</table>

Ordering Information

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Temp. Range (°C)</th>
<th>Package</th>
<th>Marking</th>
<th>Min. Order Qty.</th>
</tr>
</thead>
<tbody>
<tr>
<td>SP724AHTG</td>
<td>-40 to 105</td>
<td>Tape and Reel</td>
<td>724G</td>
<td>3000</td>
</tr>
</tbody>
</table>

Embossed Carrier Tape & Reel Specification — SOT23-6

8mm TAPE AND REEL

Notes:
1. All dimensions are in millimeters.
2. Dimensions include solder plating.
3. Dimensions are exclusive of mold flash & metal burr.
4. Pin 1 is facing up for mold and facing down for trim/form, i.e. reverse trim/form.

Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications.
Read complete Disclaimer Notice at www.littelfuse.com/disclaimer-electronics.